ABSOCIATION CONNECTING ELECTRONICE INDUSTRIES® INCLUSTRIES®	ckburn, Illinois. A	All rights reserved untions.	under both	This docume level parts, t	ent is a declara he declaration	tion of the s	substances es all low	s within the manufactu er level materials for w	rer listed i which the r	tem. Note: nanufacture	if the item is an as er has engineering	sembly with lower responsibility.	
	IPC Web Site for Information on IPC-1752 Standard Form Ty http://www.ipc.org/IPC-175x Distribut			* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials					ials and M	s and Mfg Information			
Supplier Information													
mpany name* Company unique ID			Unique			que ID Authority			Respon	Response Date*			
onsemi									2024-04-18				
Contact Name	Title - Contact				Phone - Contact*				Email - Contact*				
Product-Env-Stewards	Stewards Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com					
horized Representative* Title - Representative				Phone - Representative*				Email - Representative*					
Product-Env-Stewards Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com				
Requester Item Number Mfr I	em Number	Mfr Item Name			Effective Da	e Version	1	Manufacturing Site		Weight*	UOM	Unit Type	
NCV	CV803SQ308T1G 3.08V SUPER		V AUTO SC70		2024-04-18			MY1		6.0	mg	Each	
Manufacturing Proccess Information													
Terminal Plating / Grid Array Material	Terminal Base Alloy		J-STD-020 MSI	L Rating	Peak Pro	Process Body Temperature Max Time at Peak		Temperature Number of		ber of Reflow Cyc	les		
Matte Tin (Sn) - annealed CU Alloy 1			1		260		С	30	secor	nds 3			
Comments													
level 1 - maximum time at peak temperature during	soldering is 10-3	30 seconds											
For more information regarding material compositi	on please refer to	o page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chror	IS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead , Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl alate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.1	mg	Supplier	Silicon (Si)	7440-21-3		0.1	mg
Die Attach	0.15	mg	Supplier	Silver (Ag)	7440-22-4		0.1125	mg
			Supplier	Epoxy resins	129915-35-1		0.0375	mg
Lead Frame 1	1.93	mg	В	Nickel (Ni)	7440-02-0		0.7392	mg
			Supplier	Iron (Fe)	7439-89-6		1.021	mg
			Supplier	Copper (Cu)	7440-50-8		0.1698	mg
Mold Compound-Black	3.7	mg		Epoxy resin	proprietary data		0.185	mg
			Supplier	Phenolic Resin	Proprietary Data		0.185	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.074	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0185	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		3.2375	mg
Plating	0.11	mg	Supplier	Tin (Sn)	7440-31-5		0.11	mg
Wire Bond - Au	0.01	mg	Supplier	Gold (Au)	7440-57-5		0.01	mg